



To Our Customers

Continuing it's rich tradition of partnering with high quality Japanese semiconductor suppliers, CEL is now partnering with THine from May of 2015 onwards.



THC63LVD1023B / THC63LVD1024 Evaluation Kit

LVDS Dual Link Evaluation Board

Parts Number: THEVA1023B, THEVA1024

1. General Description

THEVA1023B and THEVA1024 are designed to evaluate THC63LVD1023B/THC63LVD1024 for transmission video data.

THC63LVD1023B and THC63LVD1024 chipset can transmit 67bit data via dual channel LVDS. The maximum input clock frequency of THC63LVD1023B is 160MHz, and the maximum output clock frequency of THC63LVD1024 is 135MHz at Dual in / Single out mode.

2. Features

Common Features

- Low power single 3.3V CMOS design
- · Power down mode
- Wide dot clock range suited for TV signal(480i to 1080p), PC signal(VGA to QXGA)
- PLL requires no external components
- · Clock edge selectable

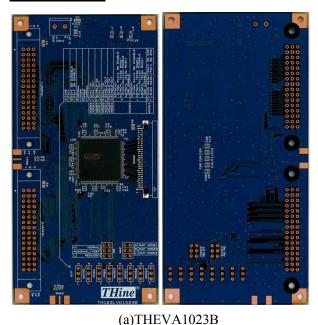
THC63LVD1023B

- Single/Dual TTL in, Single/Dual LVDS out
- Double Edge Input(Single in/Dual out Mode)
- Input Port Switch for Single TTL in/Dual out
- Asynchronous Dual TTL in / Dual LVDS out
- 3 LVDS Data Mapping Modes
- · Pseudo Random Pattern Generation Circuit
- · Support Reduced Swing LVDS for Lower EMI
- · LQFP 144 Pin

THC63LVD1024

- · Single/Dual LVDS in, Single/Dual TTL out
- · Double Edge Output
- 50% Output Clock Duty Cycle
- TTL Clock Output Timing Programmable
- 2 Output Data Mapping Modes
- LQFP 144 pin + Exposed Pad

3. Overview



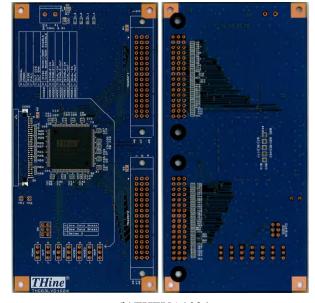


Figure 1 THEVA1023B and THEVA1024

(b)THEVA1024



2. Power Supply Setup

This chapter shows power supply condition.

Caution: Please check if there is no power-GND short on below red trace before supplying any power.

3.3V Power Supply to Each Board

Each evaluation board requires 3.3V power supply. Please use "CON1" connector typically.

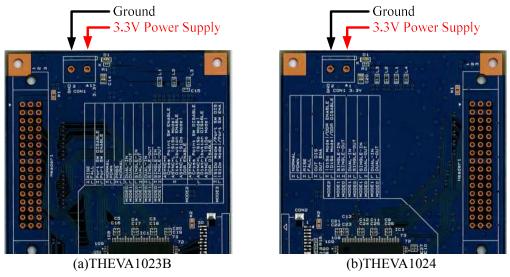


Figure 2 Power Supply for Evaluation Board

Power Supply from / to Connector

3.3V power supply can be connected to Header1 and CON2 by using W1, W2 and W3solder jumper.

THEVA1023B

- W1: Connect the 3.3V power supply with pin#1, 2 and 3 of Header1.
- W2: Connect the 3.3V power supply with pin#13 and 14 of CON2.
- W3: Connect the 3.3V power supply with pin#1, 2 and 3 of Header2.

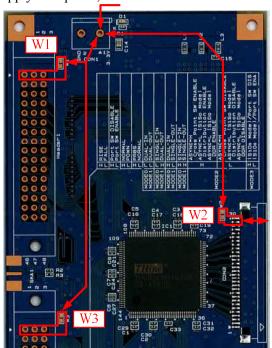


Figure 3 THEVA1023B Power Supply from / to Each Connector



THEVA1024

- W1: Connect the 3.3V power supply with pin#1, 2 and 3 of Header1.
- W2: Connect the 3.3V power supply with pin#1 and 2 of CON2.
- W3: Connect the 3.3V power supply with pin#1, 2 and 3 of Header2.

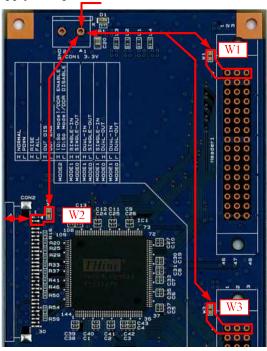
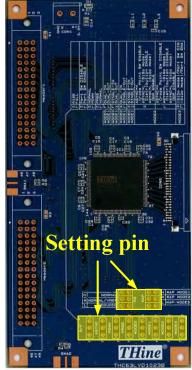


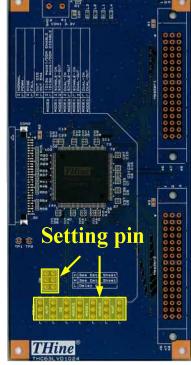
Figure 4 THEVA1024 Power Supply from / to Each Connector

3. Function Setting

Setting pin of each board is shown in yellow area of Figure 5.







(b)THEVA1024

Figure 5 Position of Function Setting Pin



Pin#2 of each 3HEADER is connected to IC's setting pin.

Each setting pin's high or low setting can set by connecting pin#2 of 3HEADER and high level or low level.

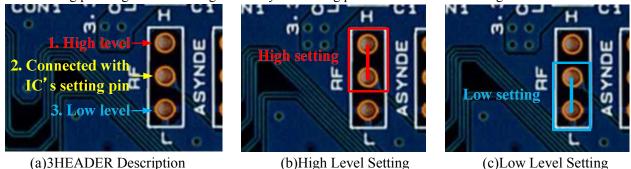


Figure 6 High / Low Setting Description

THEVA1023B and THEVA1024 have 3 level setting pin.

Please refer to Figure 7 to set the pin into each level.

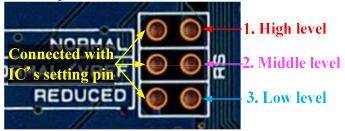


Figure 7 Description of 3Level Setting Pin

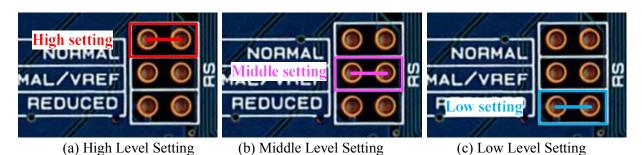


Figure 8 High / Middle / Low Setting Description

4. Clock Input from SMA Connector

THEVA1023B can also choose the TTL clock input from SMA connector by using 0ohm resistor. If you want to use SMA connector for clock input, please change the 0ohm resistor mount from R2 to R3, and R4 to R5.

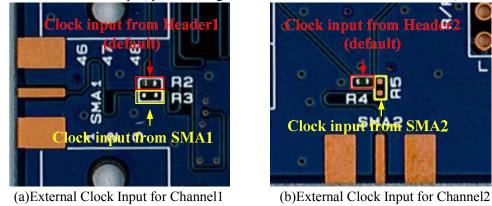


Figure 9 TTL Clock Input Connector Select



5. Status Indicate LED

LED "D1" indicates 3.3V power supply status.

6. Function

This chapter shows function setting of THEVA1023B and THEVA1024.

Table 1 THEVA1023B Function Setting Description

Silk	Symbol	Function								
		LVDS swing mode, VREF select.								
	RS				RS LV		Swing	Small Swing Input S	upport	
RS				Γ	$V_{\rm IHM}$	7 _{IHM} 350n		N/A		
					V_{IMM}	350)mV	$RS = V_{REF}$		
					$V_{\rm ILM}$	200)mV	N / A		
		LV	DS mapp	ing tab	le sele	ect				
			·······································	8			IAP	Mapping Mode		
MAP	MAP					7	IHM	Mapping MODE1		
						V	IMM	Mapping MODE2		
						V	ILM	Mapping MODE3		
MODE3	MODE3							hen $MODE[1:0] = H$, L(Single-	-in / Dual-out).
MODES	Mobes		-					Port Switch Enable		
		Th	e use of th	iese mi	ulti-fu	nction	depend	s on the setting of M	ODE[1:0]	or ASYNC.
			ASYNC MOI		DE1 MOD)	Function	MODE2	Enable / Disable
	MODE2							Cross Point	Н	Enable
MODE2			Н	X	X			Switching	L	Disable
			L L	Н		Н		Distribution	Н	Enable
							 	Function	L	Disable
					l.	L	DDI	R(Double Edge Input) Function	H L	Enable Disable
		Pix	Pixel data mode select							
MODE1										
					L		L	Dual Link (Dual-in / Dual -c		<u> </u>
					L		Н	Dual Link (Single-in		
MODE0	MODE0				Н		L	Single Link (Dual-in / Single-out)		
WODE	MODEO				Н Н		Н	Single Link (Single-in / Single-out)		
		As	ynchronou	ıs func	tion.					
ASYNC	ASYNC	H: Asynchronous Function Enable (MODE[1:0] function is enabled in this setting								
L: Asynchronous Function Disable (MODE[1:0] function is disabled in the DEF Input clock triggering edge select.								ed in this setting)		
R/F	R/F		out clock to H : Rising							
		PR	PRBS (Pseudo Random Binary Sequence) generator is active in order to evaluate eye							
PRBS	PRBS	diagram when MODE[1:0] = L, L (Dual-in / Dual-out) or ASYNC = H. H: PRBS Generator Enable L: Normal Operation								
	nn		wer down				L . INC	лінаї Орстаноп		
PDWN	PDWN	H: Normal Operation L: Power Down Mode (All outputs are Hi-Z)							·Z)	



Table 2 THEVA1024 Function Setting Description

Silk	Symbol	Function									
		LVDS swing mode, V _{REF} select.									
				MODI	E1 N	IODE0	DK	Function			
			F		!_		L	0			
	DK				L L H L		М	-6(tDOUT)/28			
DK					НН		Н	6(tDOUT)/28			
			-				L	0			
					LH		M	-7(tDOUT)/28			
							Н	7(tDOUT)/28			
		DDR function enable. The use of this function depends on the setting MODE[1:0].									
			MODE	1 MC	DE0	MODI	E2	Function			
	MODE2		L		L	L		Must be tied to G	ND		
MODE2			L	Н		Н		DDR Function En			
						L		DDR Function Dis			
		-	Н		L	L		Must be Tied to G			
			Н		Н	L		Must be Tied to G	ND		
	MODE1	Pixel data mode select									
MODE1			MOI	DE1 MODI		Ε0		Function			
			I	_	L	D	ual Li	nk (Dual-in / Dual -ou	ıt)		
		1	I	,	Н	Dual Link (Single-in / Dual -c		nk (Single-in / Dual -o	out)		
MODE0	MODE0		H L			Single Link (Dual-in / Single-o					
			H	I	Н	Sing	gle Lii	nk (Single-in / Single-	out)		
OE	OE	Output enable									
OL	OL	H : Outpu					le				
R/F	R/F	Output clock triggering edge select.									
		H : Rising Edge L : Falling Edge									
	PDWN	Power down function setting									
PDWN		H : Normal Operation									
		L : Power Down Mode (All outputs are Hi-Z)									
MAP	MAP	LVDS map									
1717 11	1717 11	H: Mapping MODE1 L: Mapping MODE2									



7. Schematic

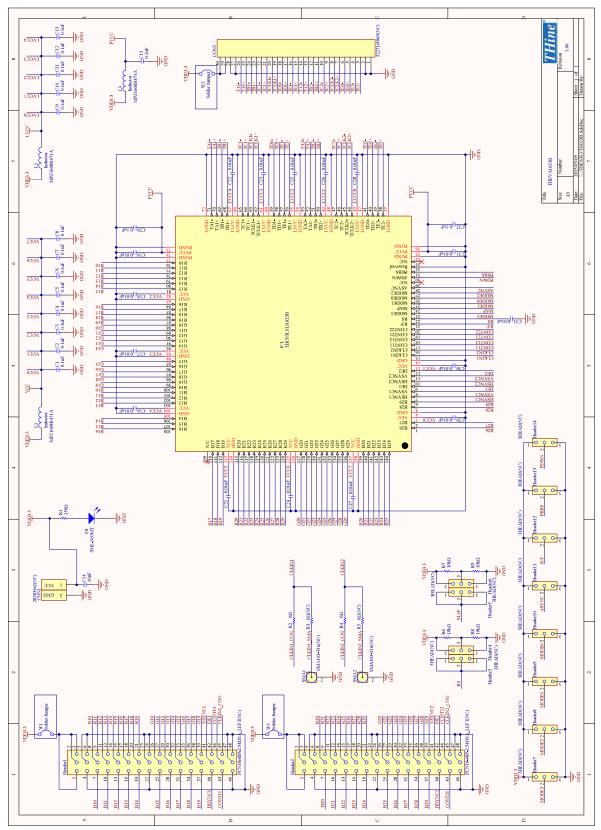


Figure 10 THEVA1023B Schematic



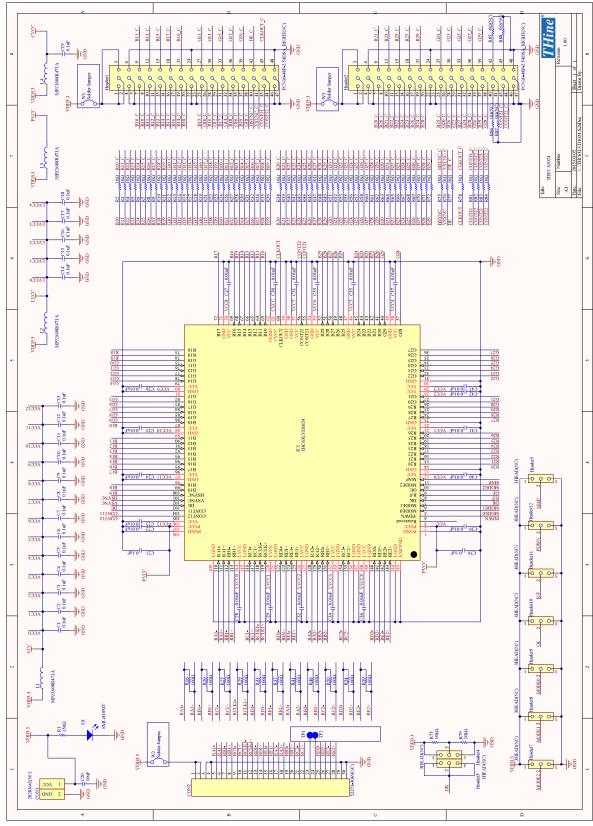


Figure 11 THEVA1024 Schematic



8. Bills of Materials

Table 3 THEVA1023B BOM

TYPE	Value / Part No.	Package	SPEC	Reference No.	Q'ty	Note
Capacitor	0.1uF	1005	16V	C1, C2, C3, C4, C5, C6, C7, C8, C9, C10, C11, C12, C13, C15, C20, C32	17	
Capacitor	10uF	2012	16V	C14	1	
Capacitor	0.01uF	1005	16V	C16, C17, C18, C19, C21, C22, C23, C24, C25, C26, C27, C28, C29, C30, C31, C33	16	
Connector	282836-2(NC)	5mm_pitch	2pin	CON1		
Connector	52271-3069(NC)	1mm_pitch	30pin	CON2	1	
Connector	PCN10-48P-2.54DSA_LEFT(NC)	2.54mm_pitch	48pin	Header1, Header2	2	
Connector	SMA103-T16(NC)	1.6mm	PCB End Jack	SMA1, SMA2	2	
Header	3HEAD(NC)	2.54mm_pitch		Header3, Header4, Header5, Header6, Header7, Header8, Header9, Header10, Header11, Header12, Header13, Header14	12	
IC	THC63LVD1023B	LQFP144		IC1	1	
Inductor	MPZ1608R471A	1608	1.2A	L1, L2, L3	3	
LED0	SML-310MT	1608	GREEN	D1	1	
Resistor	150Ω	1005	0.1W	R1	1	
Resistor	0Ω	1005	0.1W	R2, R4	2	
Resistor	$0\Omega(NC)$	1005	0.1W	R3, R5	2	
Resistor	10kΩ	1005	0.1W	R6, R7, R8, R9	4	

Table 4 THEVA1024 BOM

TYPE	Value / Part No.	Package	SPEC	Reference No.	Q'ty	Note
Capacitor	0.1uF	1005	16V	C1, C2, C3, C4, C5, C6, C7, C8, C9, C10, C11, C12, C13, C14,	21	
Capacitor	10uF	2012	16V	C20	1	
Capacitor	0.01uF	1005	16V	C22, C23, C24, C25, C26, C27, C28, C29, C30, C31, C32, C33, C34, C35, C36, C37, C39, C40, C41, C42, C43	21	
Connector	282836-2(NC)	5mm_pitch	2pin	CON1	1	
Connector	52271-3069(NC)	1mm_pitch	30pin	CON2		
Connector	PCN10-48P-2.54DSA_RIGHT(NC)	2.54mm_pitch	48pin	Header1, Header2	2	
Header	3HEAD(NC)	2.54mm_pitch		Header3, Header4, Header5, Header6, Header7, Header8,	10	
IC	THC63LVD1024	LQFP144		IC1	1	
Inductor	MPZ1608R471A	1608	1.2A	L1, L2, L3, L4	4	
LED0	SML-310MT	1608	GREEN	D1	1	
Resistor	150Ω	1005	0.1W	R1	1	
Resistor	10Ω	1005	0.1W	R2, R3, R4, R5, R6, R7, R8, R9, R10, R11, R12, R13, R14, R15, R17, R18, R19, R21, R22, R23, R24, R26, R27, R28, R30, R31, R32, R34, R35, R36, R38, R39, R40, R42, R43, R44, R45, R47, R48, R49, R51, R52, R53, R55, R56, R57, R58, R60, R61, R62,	68	
Resistor	100Ω	1005	0.1W	R16, R20, R25, R29, R33, R37, R41, R46, R50, R54, R59	11	
Resistor	10kΩ	1005	0.1W	R73, R74, R79, R80	4	
Resistor	$0\Omega(NC)$	1005	1A	R85, R86, R87, R88	4	



9. Set Items

Table 5 Set Items

ТҮРЕ	Part No.		
DC Connector	282836-2		
FFC Connector for LVDS Link	52271-3069		
FFC 30pin 1mm Pitch for LVDS Link	98267-0475		
Pin Header			

It's possible to mount these parts on this board and use.



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